



Practitioner's Docket No. U 013803-1

PATENT

RECEIPT
#13

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: CHIEN-PING HUANG

Serial No.: 09/665,818

Group No.: 2814

Filed: September 20, 2000

Examiner: --

For: SEMICONDUCTOR PACKAGE FOR ENHANCING HEAT DISSIPATION

Assistant Commissioner for Patents

Washington, D.C. 20231

SECOND REQUEST FOR CORRECTED FILING RECEIPT

1. Attached is a copy of the official filing receipt received from the PTO in the above application for which issuance of a corrected filing receipt is respectfully requested.

2. There is an error with respect to the following data, which is:

[X] incorrectly entered

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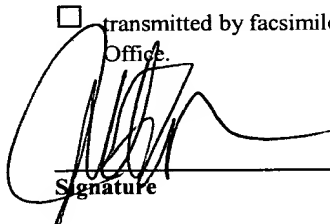
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Date: September 30, 2002


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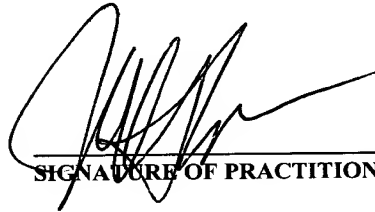
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Error in

1. ☐ Applicant's name
2. ☐ Applicant's address
3. ☐ Title
4. ☐ Filing Date
5. ☐ Serial Number
6. ☒ Attorney Docket No.:
7. ☒ Other

Correct data

- 1.
- 2.
- 3.
- 4.
- 5.
6. Delete "45688-00006 US-2953-WLJ"
Insert -- U 013803-1 --.
7. Delete "STANLEY R. MOORE ESQ....
DALLAS, TEXAS 75202-2799"
Insert -- WILLIAM R. EVANS
c/o LADAS & PARRY
26 WEST 61ST STREET
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SIGNATURE OF PRACTITIONER

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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO.	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/665,818	09/20/2000	2814	690	45688- 00006 US- 2953-WLJ	5	20	3

FILING RECEIPT



Stanley R Moore Esq
Jenkins & Gilchrist PC
3200 Fountain Place
1445 Ross Avenue
Dallas, TX 75202-2799

Date Mailed: 10/26/2000

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the PTO processes the reply to the Notice, the PTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Chien-Ping Huang, Hsinchu Hsien, TAIWAN;

Continuing Data as Claimed by Applicant

Foreign Applications

TAIWAN 89115701 08/04/2000

If Required, Foreign Filing License Granted 10/26/2000

Title

Semiconductor package for enhancing heat dissipation

Preliminary Class

257

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